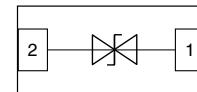


ESD Protection Diode in DFN0603

Features

- 80Watts peak pulse power ($T_p = 8/20\mu s$)
- Tiny DFN0603 package
- Bidirectional configurations
- R2R + Zener technology
- Low clamping voltage
- Low leakage current
- Medium capacitance ($C_j=20pF$ typ.)
- Protection one data/power line to:
IEC 61000-4-2 ±30kV contact ±30kV air
IEC 61000-4-4 (EFT) 40A (5/50ns)
IEC 61000-4-5 (Lightning) 10A (8/20μs)



Mechanical Data

- **Case:** DFN0603 (plastic package).
Lead free; RoHS compliant; Halogen free
- **Molding Compound Flammability Rating:**
UL 94 V-0
- **Terminals:** High temperature soldering guaranteed:
260 °C/10 sec. at terminals

Applications

- Cell Phone Handsets and Accessories
- Microprocessor based equipment
- Personal Digital Assistants (PDA's)
- Notebooks, Desktops, and Servers
- Portable Instrumentation

T

Absolute Maximum Ratings

Ratings at 25 °C, ambient temperature unless otherwise specified

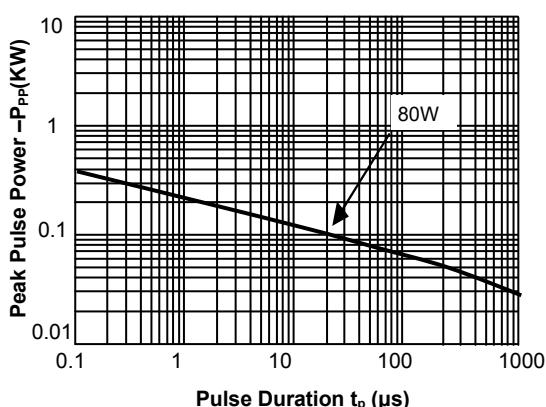
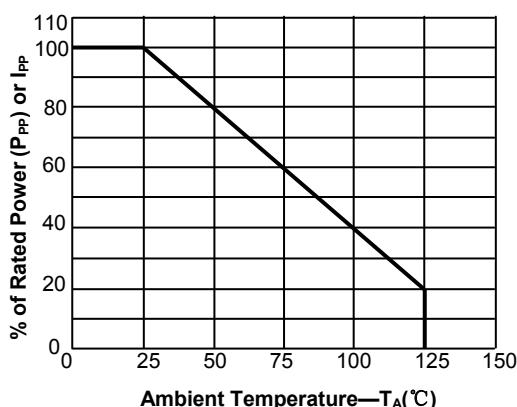
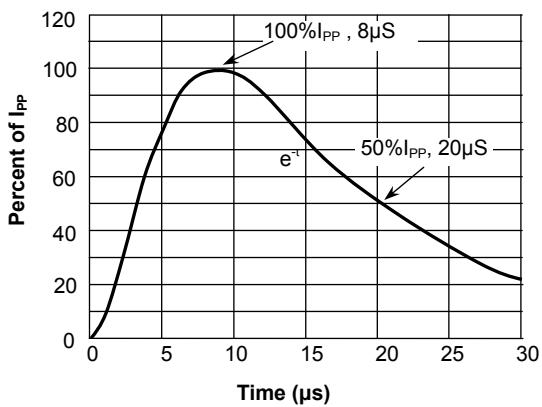
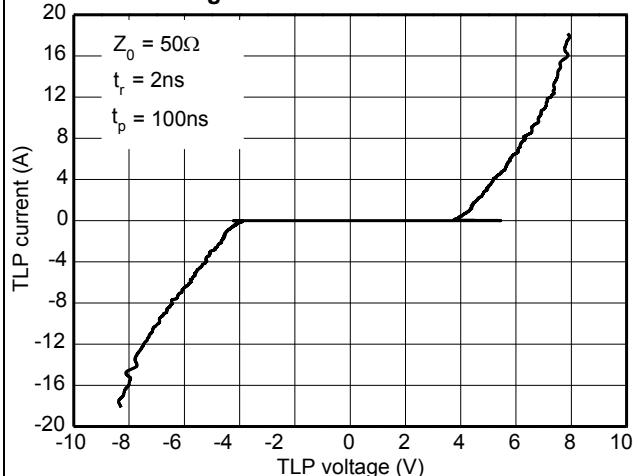
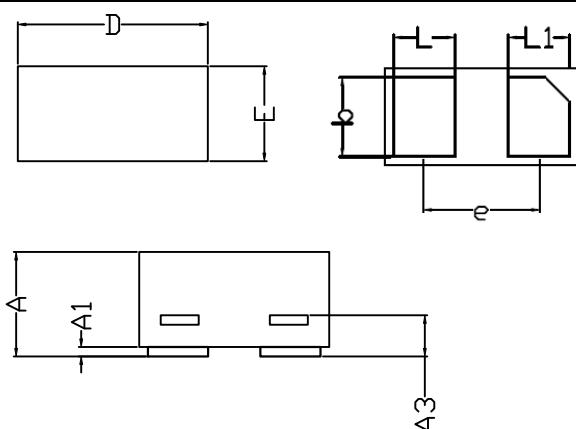
Parameter	Symbol	Value	Unit
Peak Pulse Power ($T_p=8/20\mu s$)	P_{PP}	80	W
ESD contact/air discharge (IEC-61000-4-2)	V_{ESD}	30/30	kV
Peak Pulse Current ($T_p = 8/20\mu s$)	I_{PP}	10	A
Junction Temperature	T_J	-55 to +125	°C
Storage temperature	T_{STG}	-55 to +150	°C
Maximum Lead Solder Temperature(10 second duration)	T_L	260	°C

Electrical Characteristics

($T_A = 25$ °C unless otherwise specified)

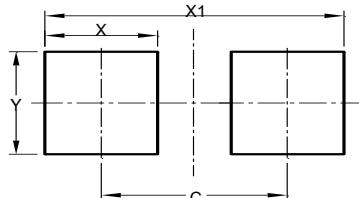
Parameter	Symbol	Condition	Min	Typ	Max	Unit
Reverse stand-off Voltage	V_{RWM}				3.3	V
Reverse Breakdown Voltage	V_{BR}	$I_T=1mA$	4.0	4.5		V
Reverse Leakage Current	I_R	$V_{RWM}=3.3V$			0.5	uA
Clamping Voltage	V_{CL}	$I_{PP}=16A, t_p=100ns$		8		V
Clamping Voltage	V_C	$I_{PP}=1A, t_p=8/20\mu s$		5		V
Clamping Voltage	V_C	$I_{PP}=10A, t_p=8/20\mu s$			8	V
Dynamic resistance	R_{dyn}			0.2		Ω
Junction Capacitance	C_J	$V_R=0V, f=1MHz$		20		pF

Typical Characteristics ($T_{amb} = 25^{\circ}\text{C}$ unless otherwise specified)

Fig.1 Peak Pulse Power Rating Curve

Fig.2 Pulse Derating Curve

Fig.3 Pulse Waveform-8/20μs

Fig.4 TLP Measurement

Package Dimensions


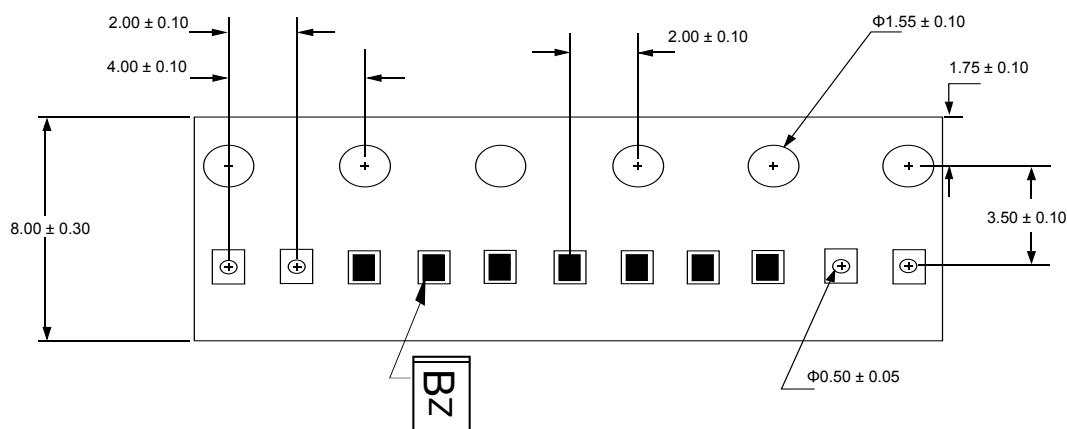
Symbol	Dimensions in millimeters		
	Min	Nom	Max
A	0.23	-	0.33
A1	0.00	-	0.05
A3	0.102 REF		
D	0.55	0.60	0.65
E	0.25	0.30	0.35
b	0.215	0.245	0.275
L	0.160	0.190	0.220
L1	0.160	0.190	0.220
e	0.355 BSC		

Pad Dimensions

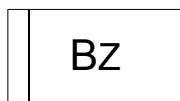


Dimensions	Value (mm)
C	0.380
X	0.230
X1	0.610
Y	0.300

Package Information



Marking



Ordering information

Order code	Package	Packaging option	Base quantity	Packaging specification
TESD0603NC3V3B-M	DFN0603	Tape and reel	10000pcs / reel	EIA STD RS-481